2008 KOREAN HONOR SCHOLARSHIP APPLICATION

PPLICANT'S	TO BE FILLED BY THE SELECTION COMMITTEE					
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PRESENT A	DDRESS					
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PERMANEN	T ADDRESS					
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DATE OF B	IRTH	th Day Yea	ar			
PLACE OF 1	BIRTH				State/Country	
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☐ Citizen			☐ Per	man	ent Resident (U	S)
☐ Citizen	of Canada				ent Resident (C	·
	of the Republi	c of Korea				
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G.P.A. (Pleas	se attach vour tra	nscript.) *For the	Last 1 Aacadem	ic Y	ear	
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^{**} The GPA should be on a 4.0 basis (Pass or Fail is not acceptable). If the transcript GPA is not on a 4.0 basis or if letter grades are given, the applicant must convert the grades into those of a 4.0 basis. Submit both the converted grades record and the official original school transcript.

III. EDUCATIONAL BACKGROUND

Name of Institution	Location	Major	Year Attended	Degree Exp.
			From Sept. 2007	
			From To	
			From To	
			From To	

IV. KOREAN LANGUAGE ABILITY (Self Evaluation, Korean-American students only)

	Excellent	Good	Poor
Speaking			
Listening			
Reading			
Writing			

V. AGREEMENT ON DATABASE

I hereby give consent and authorize the Korean Honor Scholarship Committee to keep
my personal information* on file and track any future changes of the information for the
benefit of the Korean government.
W Information such as your name hirthday schools attended (name major year) and telephone number

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To the Korean Honor Scholarship Committee;

The information submitted on this form is correct to the best of my knowledge. If any information in this application is found to be incorrect, I understand that my scholarship can be revoked.

		/	<i></i>
Signature of Applicant	Month	Day	Year

^{**} Information such as your name, birthday, schools attended(name, major, year) and telephone number, address and e-mail (to later contact you, if necessary) will be on our file. The information on your future work such as company name, address, contact number may be requested or gathered later.